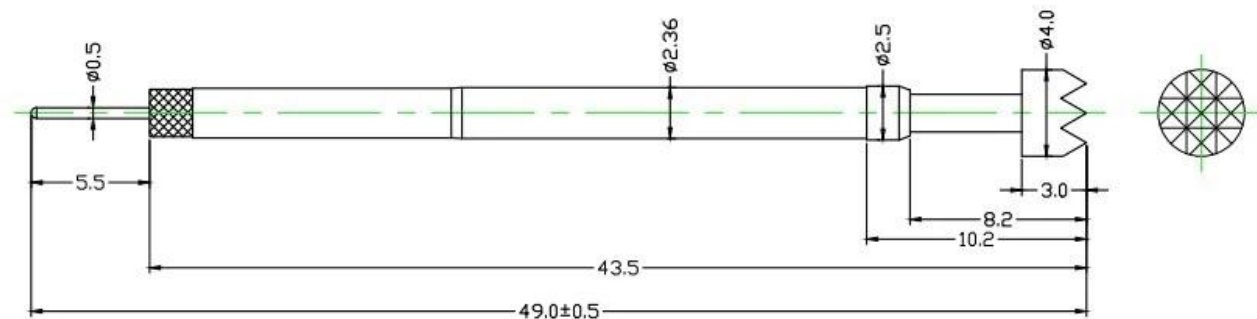


□□ □□

|       |                                                                            |
|-------|----------------------------------------------------------------------------|
| □□ □□ | SF4685                                                                     |
| □□    | □□2.36*L49.0mm                                                             |
| □□    | □□□:BeCu, Au on Ni □□<br>□□□:□□, Au on Ni □□<br>□□: SUS<br>□□ □□:Ph, Au □□ |
| □□ □□ | 1.7±0.2mm                                                                  |
| □□ □□ | 5.2mm                                                                      |
| □□ □□ | 4.2mm                                                                      |
| □□□ □ | 230±20%gf@ 4.2mm                                                           |
| MOQ   | 100PCS                                                                     |
| □□    | □/□                                                                        |
| □□ □□ | □□□□ □□ □ 5~15□                                                            |

□□ □□



□□ □□



1. raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



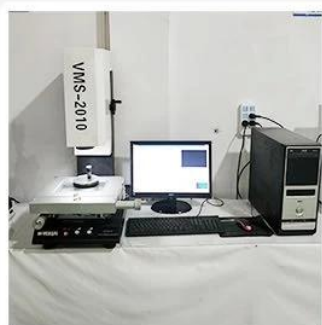
5. Finished products



6. Packing



## Measuring Equipment >



### Measuring Equipment:

1. Agilent current testing;
2. Quadratic element measurement
3. Load Curve Meter
4. Bond Test
5. Life Fatigue Test





□□ □□

1. PCB, ICT, FCT □□ □□ □□ □□ □□ (□□);
  - 2.□□, □□ □□, □□□, □□□ □ □□□□□ □□□□□□ □□ □ □□ □□ □□ □□□ □□ □□□□ □□ □□□□;
  - 3.BGA □ □□□ □□□□ □□ □□ □□ □□;
  - 4.□□□□ □□ □□ □, □□ □, QZ □ VZ □□□□ □□ LM □;
  - 5.□□□ □□□, □□□ □□□, □□□□□ □□;
  6. □□□ □ □□□/□□;
  7. □□ □□ □□ □□, □□ □□ □□, POM □ □.
- □□□□ □□ □□ □□□□ □□ □□□□. □□□ □□□ □□ □□□ □□ □□□ □□□□□ □□ □□□ □□ □□□ □□□□.

□□□ □□□

- 1.□□□ □□□ □□□ □□□□ 24□□ □□□ □□□ □□ □ □□□□.
2. □□□ □□□□ □□□□ OEM□ □□□□□.
- 3.□□□ □ □□ □□□□ □□□ □□□□ □□□ □□ □ □□□□.
- 4.□□□ □□□□ □□□□ □□□ □□ □□□□ □□□ □ □□□□.